



20V P-Channel Enhancement Mode MOSFET - ESD Protected

Voltage

-20 V

Current

-2.5A

Features

- RDS(ON), VGS@-4.5V, ID@-2.5A<85mΩ
- RDS(ON), VGS@-2.5V, ID@-1.8A<115mΩ
- RDS(ON), VGS@-1.8V, ID@-1.3A<150mΩ
- RDS(ON), VGS@-1.5V, ID@-0.5A<250mΩ
- Advanced Trench Process Technology
- Specially Designed for Switch Load, PWM Application, etc.
- Lead free in compliance with EU RoHS 2011/65/EU directive.
- Green molding compound as per IEC61249 Std. (Halogen Free)

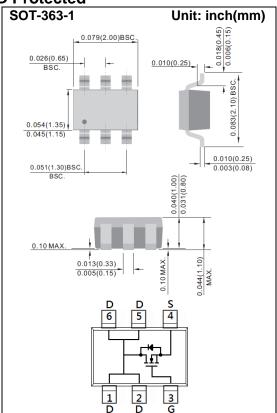
Mechanical Data

Case: SOT-363-1 Package

Terminals: Solderable per MIL-STD-750, Method 2026

Approx. Weight: 0.00028 ounces, 0.00794 grams

Marking: T13



Maximum Ratings and Thermal Characteristics ($T_A=25$ $^{\circ}$ C unless otherwise noted)

PARAMETER	SYMBOL	LIMIT	UNITS	
Drain-Source Voltage		V_{DS}	-20	V
Gate-Source Voltage		V_{GS}	<u>+</u> 12	V
Continuous Drain Current		I _D	-2.5	Α
Pulsed Drain Current (Note 4)		I _{DM}	-10	А
B	T _a =25°C	P_{D}	750	mW
Power Dissipation	Derate above 25°C		6	mW/°C
Operating Junction and Storage Tem	T_J, T_{STG}	-55~150	°C	
Typical Thermal resistance				
- Junction to Ambient (Note 3)		$R_{\theta JA}$	167	°C/W





Electrical Characteristics (T_A=25 °C unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS
Static						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =-250uA	-20	-	ı	V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$, $I_{D}=-250uA$	-0.4	-0.65	-1.2	V
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} =-4.5V, I _D =-2.5A	-	76	85	mΩ
		V _{GS} =-2.5V, I _D =-1.8A	-	92	115	
		V _{GS} =-1.8V, I _D =-1.3A	-	116	150	
		V _{GS} =-1.5V, I _D =-0.5A	-	160	250	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-20V, V _{GS} =0V	-	-0.01	-1	uA
Gate-Source Leakage Current	I _{GSS}	V _{GS} = <u>+</u> 12V, V _{DS} =0V	-	<u>+</u> 10	<u>+</u> 100	nA
Dynamic ^(Note 5)						
Total Gate Charge	Q_g	V _{DS} =-10V, I _D =-2.2A, V _{GS} =-4.5V ^(Note 1,2)	-	7	-	nC
Gate-Source Charge	Q_gs		-	1	-	
Gate-Drain Charge	Q_gd		-	1.8	-	
Input Capacitance	Ciss	V _{DS} =-10V, V _{GS} =0V, f=1.0MHZ	-	522	-	pF
Output Capacitance	Coss		-	55	-	
Reverse Transfer Capacitance	Crss		-	40	-	
Turn-On Delay Time	td _(on)	V_{DD} =-10V, I_{D} =-2.2A, V_{GS} =-4.5V, R_{G} =6 Ω (Note 1,2)	-	10	-	
Turn-On Rise Time	tr		-	4	ı	ns
Turn-Off Delay Time	td _(off)		-	34	ı	
Turn-Off Fall Time	tf		-	5	ı	
Drain-Source Diode						
Maximum Continuous Drain-Source Diode Forward Current	I _S		-	-	-1.0	А
Diode Forward Voltage	V_{SD}	I _S =-1.0A, V _{GS} =0V	-	-0.77	-1.2	V

NOTES:

- 1. Pulse width<a>300us, Duty cycle<a>2%
- 2. Essentially independent of operating temperature typical characteristics.
- 3. Rejah is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins mounted on a 1 inch FR-4 with 2oz. square pad of copper.
- 4. The maximum current rating is package limited.
- 5. Guaranteed by design, not subject to production testing





TYPICAL CHARACTERISTIC CURVES

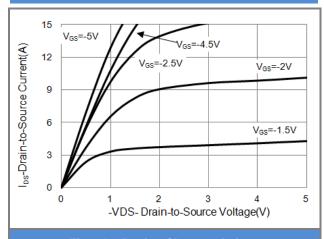


Fig.1 On-Region Characteristics

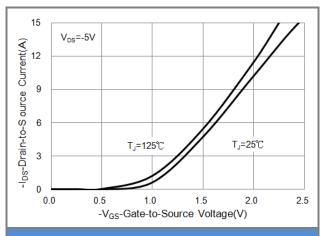


Fig.2 Transfer Characteristics

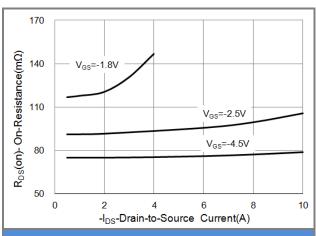


Fig.3 On-Resistance vs. Drain Current

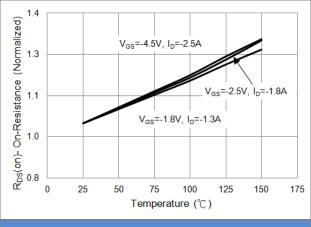


Fig.4 On-Resistance vs. Junction temperature

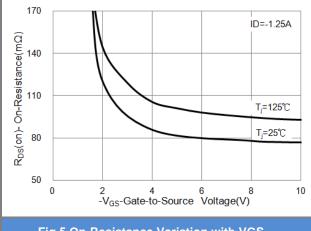


Fig.5 On-Resistance Variation with VGS.

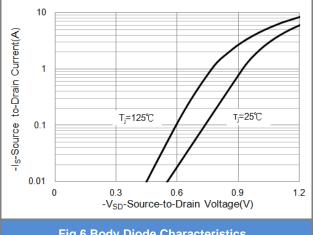


Fig.6 Body Diode Characteristics





TYPICAL CHARACTERISTIC CURVES

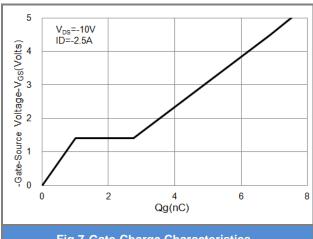


Fig.7 Gate-Charge Characteristics

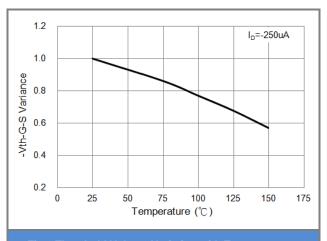


Fig.8 Threshold Voltage Variation with Temperature.

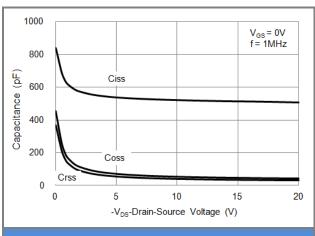


Fig.9 Capacitance vs. Drain-Source Voltage.

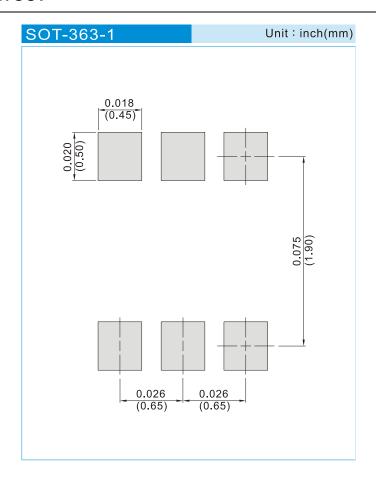




PART NO PACKING CODE VERSION

Part No Packing Code	Package Type	Packing type	Marking	Version
PJT7413_S1_00001	SOT-363-1	3K pcs / 7" reel	T13	Halogen free

MOUNTING PAD LAYOUT







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